



D5V0L1B2S9

Product Summary

V _{BR min}	Ipp max	C _{in typ}
6V	6A	15pF

Description

This new generation TVS is designed to protect sensitive electronics from the damage due to ESD. The combination of small size and high ESD surge capability make it ideal for use in portable applications such as cellular phones, digital cameras and MP3 players.

Applications

- Cellular Handsets
- Portable Electronics
- Computers and Peripheral

LOW CAPACITANCE BIDIRECTIONAL TVS DIODE

Features

- Provides ESD Protection per IEC 61000-4-2 Standard: Air ±30kV, Contact ±30kV
- 1 Channel of ESD Protection
- Low Channel Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: SOD923
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead-Free Plating). Solderable per MIL-STD-202, Method 208e3
- Weight: 0.001 grams (Approximate)



Top View





Ordering Information (Note 4)

P	Product	Compliance	Marking Reel Size (inches)		Tape Width (mm)	Quantity per Reel	
D5V(0L1B2S9-7	Standard	S/S	7	8	10,000/Tape & Reel	
Notes:							

<1000ppm antimony compounds. 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



S / S = Product Type Marking Code



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P _{PP}	84	W	8/20µs, per Figure 1
Peak Pulse Current	I _{PP}	6	А	8/20µs, per Figure 1
ESD Protection – Contact Discharge	VESD_Contact	±30	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	V _{ESD_Air}	±30	kV	IEC 61000-4-2 Standard

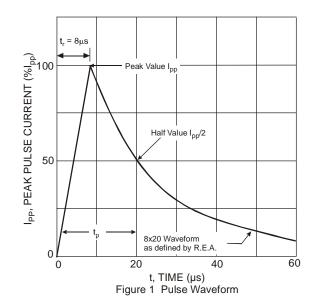
Thermal Characteristics

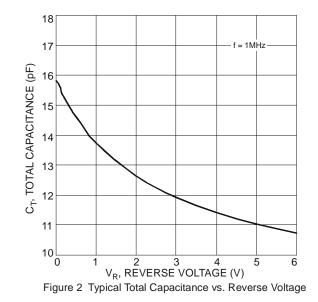
Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	PD	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	R _{θJA}	500	°C/W
Operating and Storage Temperature Range	TJ, T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Standoff Voltage	V _{RWM}	_	—	5	V	-
Channel Leakage Current (Note 6)	I _{RM}	_	10	100	nA	V _{RWM} = 5V
Clamping Voltage, Positive Transients		_	7.0	9.0	V	I _{PP} = 1A, t _p = 8/20µS
	N	_	8.7	10.7		$I_{PP} = 3A, t_p = 8/20\mu S$
	V _{CL}	_	10.5	12.0		$I_{PP} = 5A, t_p = 8/20\mu S$
		_	11.5	14.0		$I_{PP} = 6A, t_p = 8/20\mu S$
Breakdown Voltage	V _{BR}	6	7	8	V	I _R = 1mA
Differential Resistance	R _{DIF}	—	0.2	_	Ω	$I_R = 1A, t_p = 8/20\mu S$
Channel Input Capacitance	CIN	_	15	20	pF	$V_R = 0V, f = 1MHz$

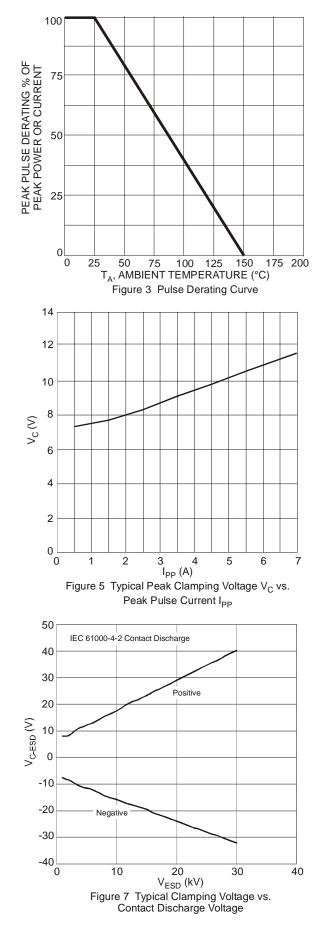
5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website Notes: at http://www.diodes.com.6. Short duration pulse test used to minimize self-heating effect.

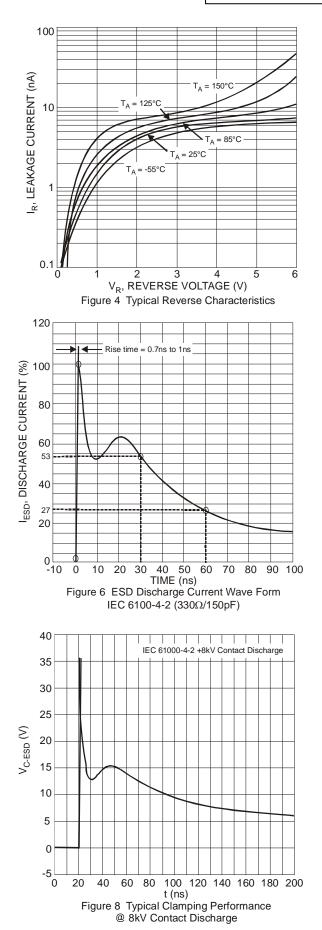






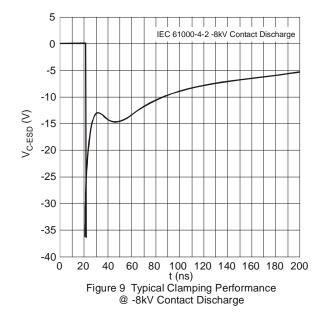
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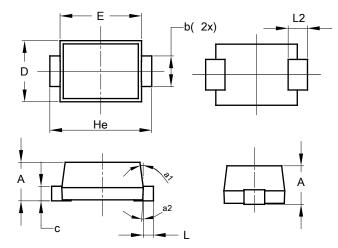
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Package Outline Dimensions

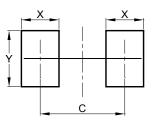
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



(0	SOD923						
•	(0.3mm Lead Width)						
Dim	Min	Max	Тур				
Α	0.34	0.40	0.37				
b	0.25	0.35	0.30				
С	0.05	0.15	0.10				
D	0.55	0.65	0.60				
E	0.75	0.85	0.80				
He	0.95	1.05	1.00				
L	0.05	0.15	0.10				
L2 0.190 REF							
a1	0°	8°	7°				
a2	2°	4°	3°				
All Dimensions in mm							

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for latest version.



Dimensions	Value (in mm)		
С	0.900		
Х	0.400		
Y	0.600		



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